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BIB DATA SHEET

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10/823,729	SERIAL NUMBER		FILING or 371(c)		CLASS		GROUP ART UNIT		ATTORNEY DOCKET		
APPLICANTS Takashi Watanabe, Kawasaki, JAPAN; Naoki Idani, Kawasaki, JAPAN; Toshiyuki Isome, Kawasaki, JAPAN; ****CONTINUING DATA **********************************	10/823,729					438	2818				
Takashi Watanabe, Kawasaki, JAPAN; Naoki Idani, Kawasaki, JAPAN; Toshiyuki Isome, Kawasaki, JAPAN; **CONTINUING DATA***** **FOREIGN APPLICATIONS***** JAPAN 2003-283810 07/31/2003 JAPAN 2004-13357 01/21/2004 **IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 06/25/2004 Foreign Priority claimed			RUL	E							
** FOREIGN APPLICATIONS *** JAPAN 2003-283810 07/31/2003 JAPAN 2004-13357 01/21/2004 ** IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 06/25/2004 Foreign Priority claimed	Takashi Watanabe, Kawasaki, JAPAN; Naoki Idani, Kawasaki, JAPAN;										
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35 USC 119(a-d) conditions met 2 Yes \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \											
Verified and Acknowledged /DAVID VU/ Examiner's Signature	· ·			☐ Met after				_			
WESTERMAN, HATTORI, DANIELS & ADRIAN, LLP 1250 CONNECTICUT AVENUE, NW SUITE 700 WASHINGTON, DC 20036 UNITED STATES TITLE Semiconductor device fabrication method FILING FEE RECEIVED 1262 FEES: Authority has been given in Paper No to charge/credit DEPOSIT ACCOUNT No for following: All Fees All Fees In 1.16 Fees (Filing) 1.17 Fees (Processing Ext. of time) 1.18 Fees (Issue) Other Other	Verified and /DAVID VU/		Allowance								
1250 CONNECTICUT AVENUE, NW SUITE 700 WASHINGTON, DC 20036 UNITED STATES TITLE Semiconductor device fabrication method FEES: Authority has been given in Paper No to charge/credit DEPOSIT ACCOUNT No for following: All Fees 1.16 Fees (Filing) 1.17 Fees (Processing Ext. of time) 1.18 Fees (Issue) Other Other Other Other	ADDRESS										
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